

GA060TH65

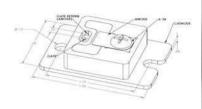
Silicon Carbide Thyristor

V _{FBM}	=	6500 V	
I _{T(AVM)}	=	60 A	
Q _{rr}	=	2.95 μC	

Features

- 6500 V Asymmetric SiC NPNP Thyristor
- 150 °C operating temperature
- · Robust compact fully soldered package
- SOT-227 (ISOTOP) base plate form factor
- Fast turn on characteristics
- Lowest in class $Q_{rr}/I_{T(AVM)}$

- Applications
 Grid Tied Solar Inverters
- Wind Power Inverters
- HVDC Power Conversion
- Utility Scale Power Conversion
- Trigger Circuits/Ignition Circuits



Package



Maximum Ratings

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak forward voltage	V_{FBM}	T _j = 25 °C	6500	V
Repetitive peak reverse voltage	V_{RBM}	T _j = 25 °C	50	V
Maximum average on-state current	I _{T(AVM)}	T _c ≤ 120 °C	60	Α
RMS on-state current	I _{T(RMS)}	T _c ≤ 120 °C	104	Α
Non-repetitive peak on-state current	I _{T,max}	$T_{\rm C}$ = 25 °C, $t_{\rm p}$ = 2 us, D = 0.1	tbd	Α
Power dissipation	P _{tot}	T _c = 25 °C	919	W
Operating and storage temperature	T _i , T _{sta}		-55 to 150	°C

Electrical Characteristics

Parameter	Cumbal	Conditions	Values		Unit	
	Symbol		min.	typ.	max.	Ullit
Maximum neek on state valtage	V	I _K = -60 A, T _j = 25 °C		-3.90		.,
Maximum peak on state voltage	$V_{KA(ON)}$	$I_{K} = -60 \text{ A}, T_{j} = 150 ^{\circ}\text{C}$		-3.70		V
Anode-cathode threshold voltage	$V_{KA(TO)}$	T _j = 25 °C (150 °C)		-3.1(-2.8)		V
Anode-cathode slope resistance	R _{AK}	T_{j} = 25 °C (150 °C), I_{K} = -60 A		9.4(9.5)		mΩ
Lookaga aurrent	1	$V_{KA} = -6500 \text{ V}, V_{GA} = 0 \text{ V}, T_{j} = 25 ^{\circ}\text{C}$		20		μA
Leakage current	'L	$V_{KA} = -6500 \text{ V}, V_{GA} = 0 \text{ V}, T_{j} = 150 ^{\circ}\text{C}$		50		
Gate trigger current	I _{GT}	$T_{j} = 25 ^{\circ}\text{C}, t_{p} = 10 \mu\text{s}$		-100		mA
Holding current	I _H	T _j = 25 °C		tbd		mA
Rise time	t _R	I _G = -3 A, V _{KA} = -2200 V		170		ns
Delay time	$t_{_{\mathrm{D}}}$	$I_{K} = -60 \text{ A}, T_{j} = 25 ^{\circ}\text{C}$		45		ns
Reverse recovery charge	Q _{rr}			2.95		μC
Recovered charge, 50% chord	Q_{ra}	$dI/dt = 360 \text{ A/us}, I_{K} = -60 \text{ A}, V_{KA} = 20 \text{ V}$		1.6		μC
Reverse recovery current	I _{rm}	$dV/dt(re-app) = -362 V/us, T_j = 25 °C$		15		Α
Circuit commutated turn-off time	t_{q}			6.7		μs

Thermal Characteristics

Thermal resistance, junction - case	R_{thJC}		0.136	°C/W
Mechanical Properties				
Mounting torque for base	M _b	Heat sink surface must be optically flat	1.5	Nm
Mounting torque for top	M _t	. ,	1.3	Nm
Weight	W _t		30	g

1. Considering worst case Z_{th} conditions



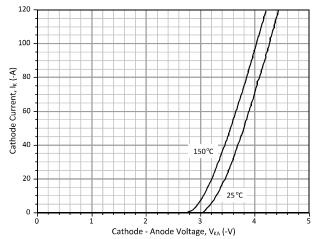


Figure 1: Typical On State Characteristics

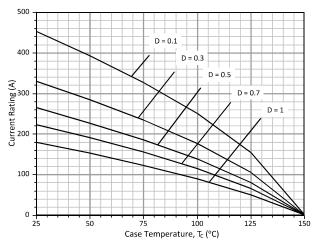


Figure 3: Typical Current Derating Curves (D = t_p/T , t_p = 400 μ s¹)

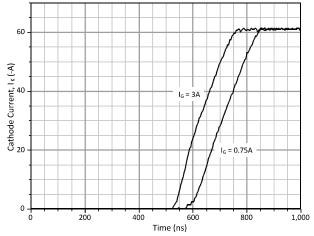


Figure 5: Typical Turn On Characteristics at 25 °C

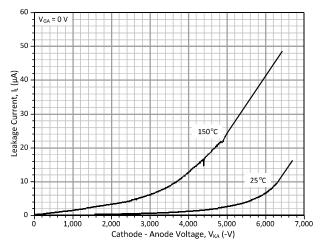


Figure 2: Typical Forward Blocking Characteristics

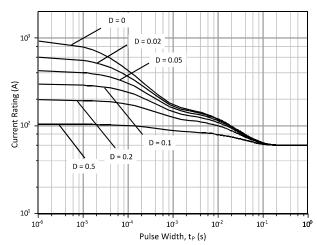


Figure 4: Typical Current Rating versus Pulse Duration Curves at $T_{\rm c}$ = 120 $^{\rm o}$ C

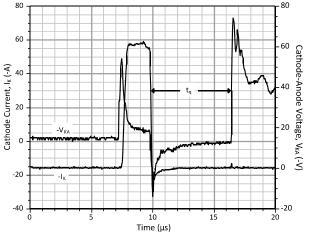
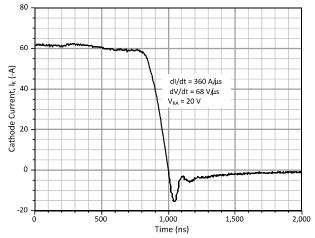


Figure 6: Typical Turn Off Characteristics at 25 °C







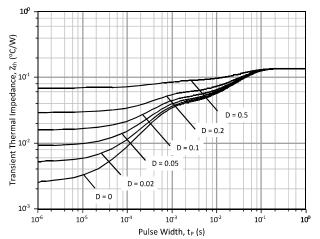


Figure 8: Typical Transient Thermal Impedance

Revision History				
Date	Revision	Comments	Supersedes	
2010/11/10	1	First generation release		

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